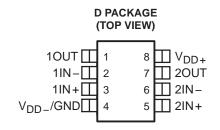
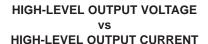
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- **Qualified for Automotive Applications**
- **ESD Protection Exceeds 2000 V Per** MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- **Output Swing Includes Both Supply Rails**
- **Extended Common-Mode Input Voltage** Range . . . 0 V to 4.5 V (Min) With 5-V Single Supply
- No Phase Inversion
- Low Noise . . . 18 nV/ $\sqrt{\text{Hz}}$ Typ at f = 1 kHz
- **Low Input Offset Voltage** 950 μ V Max at T_A = 25°C (TLV2422A)
- Low Input Bias Current . . . 1 pA Typ
- Micropower Operation . . . 50 µA Per Channel
- **600-** Ω Output Drive

description

The TLV2422 and TLV2422A are dual low-voltage operational amplifiers from Texas Instruments. The common-mode input voltage range for this device has been extended over the typical CMOS amplifiers making them suitable for a wide range of applications. In addition, the devices do not phase invert when the common-mode input is driven to the supply rails. This satisfies most design requirements without paying a premium for rail-to-rail input performance. They also exhibit rail-to-rail output performance for increased dynamic range in single- or split-supply applications. This family is fully characterized at





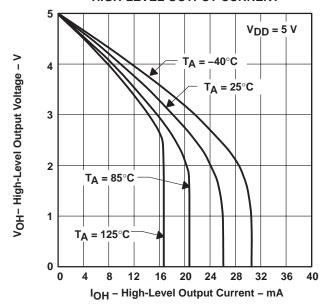


Figure 1

3-V and 5-V supplies and is optimized for low-voltage operation. The TLV2422 only requires 50 μA of supply current per channel, making it ideal for battery-powered applications. The TLV2422 also has increased output drive over previous rail-to-rail operational amplifiers and can drive $600-\Omega$ loads for telecom applications.

Other members in the TLV2422 family are the high-power, TLV2442, and low-power, TLV2432, versions.

The TLV2422, exhibiting high input impedance and low noise, is excellent for small-signal conditioning for high-impedance sources, such as piezoelectric transducers. Because of the micropower dissipation levels and low-voltage operation, these devices work well in hand-held monitoring and remote-sensing applications. In addition, the rail-to-rail output feature with single- or split-supplies makes this family a great choice when interfacing with analog-to-digital converters (ADCs). For precision applications, the TLV2422A is available with a maximum input offset voltage of 950 μV.

If the design requires single operational amplifiers, see the TI TLV2211/21/31. This is a family of rail-to-rail output operational amplifiers in the SOT-23 package. Their small size and low power consumption, make them ideal for high density, battery-powered equipment.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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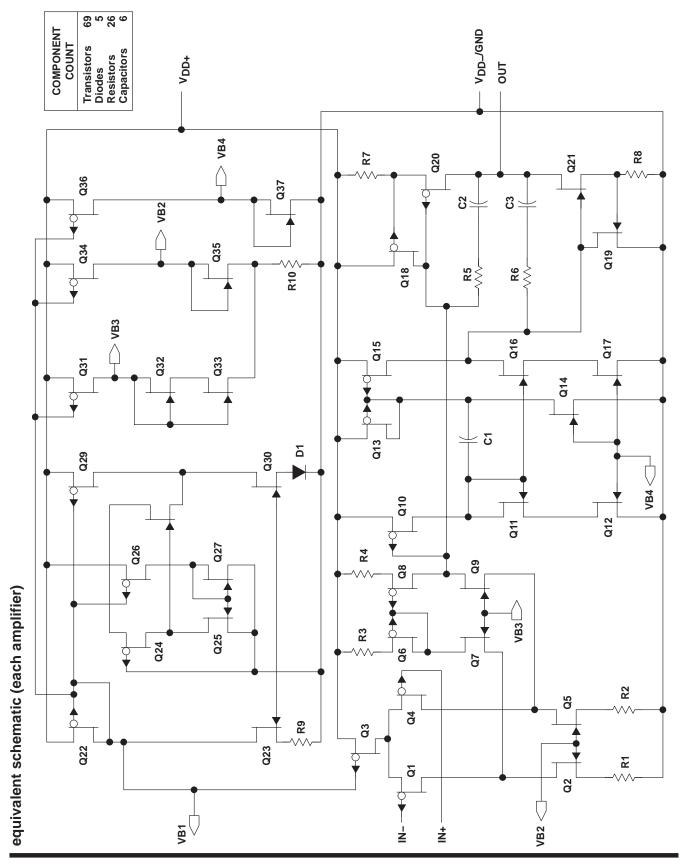
ORDERING INFORMATION[†]

TA	V _{IO} max AT 25°C	PACK	AGE [‡]	ORDERABLE PART NUMBER	TOP-SIDE MARKING
4000 1- 40500	950 μV	SOIC (D)	Tape and reel	TLV2422AQDRQ1	2422AQ
-40°C to 125°C	2.5 mV	SOIC (D)	Tape and reel	TLV2422QDRQ1	2422Q1

[†] For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at http://www.ti.com.



[‡] Package drawings, thermal data, and symbolization are available at http://www.ti.com/packaging.



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{DD} (see Note 1)	
Differential input voltage, V _{ID} (see Note 2)	
Input voltage, V _I (any input, see Note 1): C and I suffix	–0.3 V to V _{DD}
Input current, I _I (each input)	±5 mA
Output current, I _O	±50 mA
Total current into V _{DD+}	±50 mA
Total current out of V _{DD}	±50 mA
Duration of short-circuit current at (or below) 25°C (see Note 3)	unlimited
Continuous total power dissipation	. See Dissipation Rating Table
Operating free-air temperature range, T _A : Q suffix	–40°C to 125°C
Storage temperature range, T _{stq}	–65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values, except differential voltages, are with respect to the midpoint between V_{DD+} and V_{DD-}.
 - 2. Differential voltages are at IN+ with respect to IN-. Excessive current flows if input is brought below $V_{DD} = 0.3 \text{ V}$.
 - 3. The output may be shorted to either supply. Temperature and/or supply voltages must be limited to ensure that the maximum dissipation rating is not exceeded.

DISSIPATION RATING TABLE

PACKAGE	$T_{\mbox{A}} \le 25^{\circ}\mbox{C}$ Power rating	DERATING FACTOR ABOVE T _A = 25°C	T _A = 70°C POWER RATING	T _A = 85°C POWER RATING	T _A = 125°C POWER RATING
D	725 mW	5.8 mW/°C	464 mW	377 mW	145 mW

recommended operating conditions

	MIN	MAX	UNIT
Supply voltage, V _{DD±}	2.7	10	V
Input voltage range, V _I	V_{DD-}	V _{DD+} -0.8	V
Common-mode input voltage, V _{IC}	V_{DD-}	V _{DD+} -0.8	V
Operating free-air temperature, T _A	-40	125	°C



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electrical characteristics at specified free-air temperature, V_{DD} = 3 V (unless otherwise noted)

	DADAMETED	TEST CO	TEST CONDITIONS		TL	V2422-0	21	TLV	/2422A-	Q1		
	PARAMETER	TEST CONDITIONS		T _A †	MIN	TYP	MAX	MIN	TYP	MAX	UNIT	
.,	land offeet value			25°C		300	2000		300	950	/	
V _{IO}	Input offset voltage			Full range			2500			1800	μV	
αVIO	Temperature coefficient of input offset voltage			Full range		2			2		μV/°C	
	Input offset voltage long-term drift (see Note 4)	V _{IC} = 0, V _O = 0,	$V_{DD}\pm = \pm 1.5 \text{ V},$ $R_S = 50 \Omega$	25°C		0.003			0.003		μV/mo	
lio	Input offset current			25°C		0.5	60		0.5	60	pА	
lio	input onset current			Full range			150			150	PΑ	
lin	Input bias current			25°C		1	60		1	60	рА	
I _{IB}	input bias current			Full range			300			300	PΑ	
V:	Common-mode input		P = = 50 O	25°C	0 to 2.5	-0.25 to 2.75		0 to 2.5	-0.25 to 2.75		V	
VICR	voltage range	$ V_{IO} \le 5 \text{ mV},$	$R_S = 50 \Omega$	Full range	0 to 2.2			0 to 2.2			V	
		I _{OH} = -100 μA		25°C		2.97			2.97			
Vон	VOH voltage			25°C		2.75			2.75		V	
		$I_{OH} = -500 \mu A$		Full range	2.5			2.5			<u> </u>	
		V _{IC} = 0,	$I_{OL} = 100 \mu A$	25°C		0.05			0.05			
V_{OL}	Low-level output voltage	V 0	I 250 A	25°C		0.2			0.2		V	
	remage	$V_{IC} = 0$,	I _{OL} = 250 μA	Full range			0.5			0.5		
	Large-signal		R _L = 10 kه	25°C	6	10		6	10			
A_{VD}	differential voltage	$V_{IC} = 1.5 \text{ V},$ $V_{O} = 1 \text{ V to 2 V}$	_	Full range	2			2			V/mV	
	amplification	10-111521	$R_L = 1 M\Omega^{\ddagger}$	25°C		700			700			
^r i(d)	Differential input resistance			25°C		1012			1012		Ω	
r _{i(c)}	Common-mode input resistance			25°C		1012			1012		Ω	
Ci(c)	Common-mode input capacitance	f = 10 kHz		25°C		8			8		pF	
z _o	Closed-loop output impedance	f = 100 kHz,	A _V = 10	25°C		130			130		Ω	
CMDD	Common-mode	V _{IC} = V _{ICR} min,	V _O = 1.5 V,	25°C	70	83		70	83		45	
CMRR	rejection ratio	$R_S = 50 \Omega$			70			70			dB	
	Supply-voltage	V _{DD} = 2.7 V to 8	: V	25°C	80	95		80	95			
k _{SVR}	rejection ratio	$V_{IC} = V_{DD}/2$	No load	Full range	80			80			dB	
	(ΔV _{DD} /ΔV _{IO})			25°C	00	100	150	00	100	150		
I_{DD}	Supply current $V_O = 1.5 \text{ V}$, No load		No load	Full range		100	150		100	150 175	μΑ	
			ruii range			175			1/5			

[†]Full range is -40°C to 125°C for Q level part.

NOTE 4: Typical values are based on the input offset voltage shift observed through 500 hours of operating life test at $T_A = 150$ °C extrapolated to $T_A = 25$ °C using the Arrhenius equation and assuming an activation energy of 0.96 eV.



[‡]Referenced to 1.5 V

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operating characteristics at specified free-air temperature, $V_{DD} = 3 V$

PARAMETER		TER TEST CONDITIONS TA		T _A †	TLV2422-Q1, TLV2422A-Q1			UNIT
				MIN	TYP	MAX		
		V- 44V4-40V	D. 40 hot	25°C	0.01	0.02		
SR	Slew rate at unity gain	$V_O = 1.1 \text{ V to } 1.9 \text{ V},$ $C_L = 100 \text{ pF}^{\ddagger}$	$RL = 10 \text{ K}\Omega + 1$	Full range	0.008			V/μs
.,	Emphysical format major walks as	f = 10 Hz		25°C		100		nV/√ Hz
Vn	Equivalent input noise voltage	f = 1 kHz		25°C		23		nv/√Hz
.,	Pool to made and all the state of the college	f = 0.1 Hz to 1 Hz		25°C		2.7		.,
VN(PP)	Peak-to-peak equivalent input noise voltage	f = 0.1 Hz to 10 Hz	25°C		4		μV	
In	Equivalent input noise current			25°C	0.6			fA√Hz
TUD . N	Total because its distortion releases	$V_0 = 0.5 \text{ V to } 2.5 \text{ V}, A_V = 1$		0500		0.25%		
THD + N	Total harmonic distortion plus noise	$f = 1 \text{ kHz},$ $R_L = 10 \text{ k}\Omega^{\ddagger}$	A _V = 10	25°C		1.8%		
	Gain-bandwidth product	f = 10 kHz, C _L = 100 pF [‡]	$R_L = 10 \text{ k}\Omega^{\ddagger}$,	25°C		46		kHz
ВОМ	Maximum output-swing bandwidth	$V_{O(PP)} = 1 \text{ V},$ $R_{L} = 10 \text{ k}\Omega^{\ddagger},$	A _V = 1, C _L = 100 pF‡	25°C		8.3		kHz
	Sottling time	$A_V = -1$, Step = 0.5 V to 2.5 V,	To 0.1%	25°C		8.6		
t _S	Settling time	$R_L = 10 \text{ k}\Omega^{\ddagger}$, $C_L = 100 \text{ pF}^{\ddagger}$	To 0.01%	25 0		16		μs
φm	Phase margin at unity gain	B. = 10 kOt.	C _L = 100 pF [‡]	25°C		62°		
	Gain margin	$R_L = 10 \text{ k}\Omega^{\ddagger}$	CL = 100 pF+	25°C		11		dB

[†] Full range is –40°C to 125°C for Q level part.



[‡]Referenced to 1.5 V

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electrical characteristics at specified free-air temperature, V_{DD} = 5 V (unless otherwise noted)

	DADAMETED	TEST CO	TEST CONDITIONS		TL	V2422-0	21	TLV	/2422A-	Q1	
	PARAMETER	TEST CONDITIONS		T _A †	MIN	TYP	MAX	MIN	TYP	MAX	UNIT
.,	land offert value			25°C		300	2000		300	950	/
V _{IO}	Input offset voltage			Full range			2500			1800	μV
αΝΙΟ	Temperature coefficient of input offset voltage			Full range		2			2		μV/°C
	Input offset voltage long-term drift (see Note 4)	V _{IC} = 0, V _O = 0,	$V_{DD}\pm = \pm 2.5 \text{ V},$ $R_S = 50 \Omega$	25°C		0.003			0.003		μV/mo
lio	Input offset current			25°C		0.5	60		0.5	60	pА
lio	input onset current			Full range			150			150	PΑ
lin	Input bias current			25°C		1	60		1	60	рА
IΒ	input bias current			Full range			300			300	PΑ
V _{ICR}	Common-mode input	V _{IO} ≤ 5 mV,	$R_S = 50 \Omega$	25°C	0 to 4.5	-0.25 to 4.75		0 to 4.5	-0.25 to 4.75		V
VICR	voltage range	\v O ≥ 3 mv,	NS = 30 22	Full range	0 to 4.2			0 to 4.2			V
		$I_{OH} = -100 \mu A$		25°C		4.97			4.97		
∨он	VOH High-level output voltage	I _{OH} = -1 mA		25°C		4.75			4.75		V
	voltage			Full range	4.5			4.5			
	Laurelaurelaure	$V_{IC} = 2.5 V$,	$I_{OL} = 100 \mu A$	25°C		0.04			0.04		
V_{OL}	Low-level output voltage	V _{IC} = 2.5 V,	I _{OL} = 500 μA	25°C		0.15			0.15		V
		VIC = 2.5 V,	ΙΟΓ = 200 μΑ	Full range			0.5			0.5	
	Large-signal	.,	R _L = 10 kه	25°C	8	12		8	12		
AVD	differential voltage	$V_{IC} = 2.5 \text{ V},$ $V_{O} = 1 \text{ V to 4 V}$	_	Full range	3			3			V/mV
	amplification	10 11011	$R_L = 1 M\Omega^{\ddagger}$	25°C		1000			1000		
ri(d)	Differential input resistance			25°C		1012			1012		Ω
r _{i(c)}	Common-mode input resistance			25°C		1012			1012		Ω
Ci(c)	Common-mode input capacitance	f = 10 kHz		25°C		8			8		pF
z _O	Closed-loop output impedance	f = 100 kHz,	A _V = 10	25°C		130			130		Ω
01/55	Common-mode	VIC = VICR min,	V _O = 2.5 V,	25°C	70	90		70	90		
CMRR	rejection ratio	$R_S = 50 \Omega$		Full range	70			70			dB
	Supply-voltage	$V_{DD} = 4.4 \text{ V to } $	R \/	25°C	80	95		80	95		
ksvr	rejection ratio	$V_{IC} = V_{DD}/2$	o v, No load	Full range	80			80			dB
	(ΔV _{DD} /ΔV _{IO})	22		Ŭ	00	100	150	00	100	150	
I _{DD}	Supply current $V_O = 2.5 \text{ V}$, No load		No load	25°C		100	150		100	150	μΑ
			Full range			175			175		

[†]Full range is -40°C to 125°C for Q level part.

NOTE 4: Typical values are based on the input offset voltage shift observed through 500 hours of operating life test at $T_A = 150$ °C extrapolated to $T_A = 25$ °C using the Arrhenius equation and assuming an activation energy of 0.96 eV.



[‡]Referenced to 2.5 V

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operating characteristics at specified free-air temperature, $V_{DD} = 5 \text{ V}$

PARAMETER		PARAMETER TEST CONDITIONS TA [†]				/2422-Q 2422A-0	,	UNIT
				MIN	TYP	MAX		
		V 45V4 05V4	D 4010†	25°C	0.01	0.02		
SR	Slew rate at unity gain	$V_O = 1.5 \text{ V to } 3.5 \text{ V},$ $C_L = 100 \text{ pF}^{\ddagger}$	$R_L = 10 \text{ K}\Omega + ,$	Full range	0.008			V/μs
.,	Englished the of a size william	f = 10 Hz		25°C		100		->44
Vn	Equivalent input noise voltage	f = 1 kHz		25°C		18		nV/√Hz
.,	Post to a set on the least to set of second set of	f = 0.1 Hz to 1 Hz		25°C		1.9		.,
V _{N(PP)}	Peak-to-peak equivalent input noise voltage	f = 0.1 Hz to 10 Hz	25°C		2.8		μV	
In	Equivalent input noise current			25°C		0.6		fA√ Hz
TUD . N	Total beautiful distriction above as in	$V_0 = 1.5 \text{ V to } 3.5 \text{ V},$				0.24%		
THD + N	Total harmonic distortion plus noise	$f = 1 \text{ kHz},$ $R_L = 10 \text{ k}\Omega^{\ddagger}$	A _V = 10	25°C	1.7%			
	Gain-bandwidth product	f = 10 kHz, C _L = 100 pF [‡]	$R_L = 10 \text{ k}\Omega^{\ddagger}$,	25°C		52		kHz
ВОМ	Maximum output-swing bandwidth	$V_{O(PP)} = 2 \text{ V},$ $R_{L} = 10 \text{ k}\Omega^{\ddagger},$	A _V = 1, C _L = 100 pF [‡]	25°C		5.3		kHz
	Settling time	$A_V = -1$, Step = 1.5 V to 3.5 V,	To 0.1%	25°C		8.5		
t _S	Setuing unit	$R_L = 10 \text{ k}\Omega^{\ddagger}$, $C_L = 100 \text{ pF}^{\ddagger}$	To 0.01%	20 C		15.5		μs
φm	Phase margin at unity gain	$R_L = 10 \text{ k}\Omega^{\ddagger,}$	C _L = 100 pF [‡]	25°C		66°		
	Gain margin	K	CL = 100 pr+	25°C		11		dB

[†] Full range is -40°C to 125°C for Q level part.

[‡]Referenced to 2.5 V

TYPICAL CHARACTERISTICS

Table of Graphs

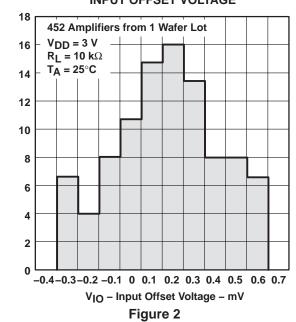
			FIGURE
V _{IO}	Input offset voltage	Distribution vs Common-mode input voltage	2,3 4,5
ανιο	Input offset voltage temperature coefficient	Distribution	6,7
I _{IB} /I _{IO}	Input bias and input offset currents	vs Free-air temperature	8
Vон	High-level output voltage	vs High-level output current	9,11
VOL	Low-level output voltage	vs Low-level output current	10,12
VO(PP)	Maximum peak-to-peak output voltage	vs Frequency	13
Ios	Short-circuit output current	vs Supply voltage vs Free-air temperature	14 15
V _{ID}	Differential input voltage	vs Output voltage	16,17
	Differential gain	vs Load resistance	18
A _{VD}	Large-signal differential voltage amplification Differential voltage amplification	vs Frequency vs Free-air temperature	19,20 21,22
z _O	Output impedance	vs Frequency	23,24
CMRR	Common-mode rejection ratio	vs Frequency vs Free-air temperature	25 26
ksvr	Supply-voltage rejection ratio	vs Frequency vs Free-air temperature	27,28 29
I _{DD}	Supply current	vs Supply voltage	30
SR	Slew rate	vs Load capacitance vs Free-air temperature	31 32
Vo	Inverting large-signal pulse response		33,34
VO	Voltage-follower large-signal pulse response		35,36
VO	Inverting small-signal pulse response		37,38
Vo	Voltage-follower small-signal pulse response		39,40
V _n	Equivalent input noise voltage	vs Frequency	41, 42
	Noise voltage (referred to input)	Over a 10-second period	43
THD + N	Total harmonic distortion plus noise	vs Frequency	44,45
	Gain-bandwidth product	vs Supply voltage vs Free-air temperature	46 47
φm	Phase margin	vs Frequency vs Load capacitance	19,20 48
	Gain margin	vs Load capacitance	49
B ₁	Unity-gain bandwidth	vs Load capacitance	50

Percentage of Amplifiers – %

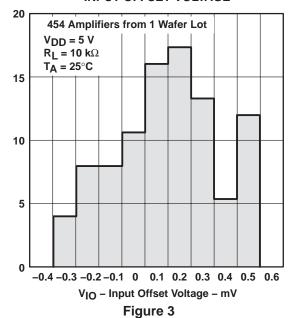
DISTRIBUTION OF TLV2422 INPUT OFFSET VOLTAGE

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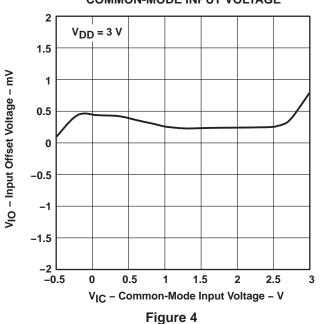
Percentage of Amplifiers - %



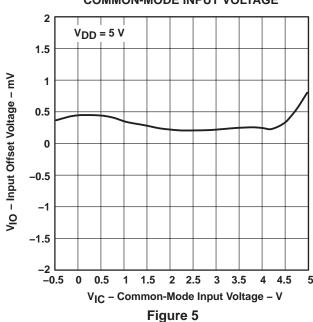
DISTRIBUTION OF TLV2422 INPUT OFFSET VOLTAGE



INPUT OFFSET VOLTAGE vs COMMON-MODE INPUT VOLTAGE

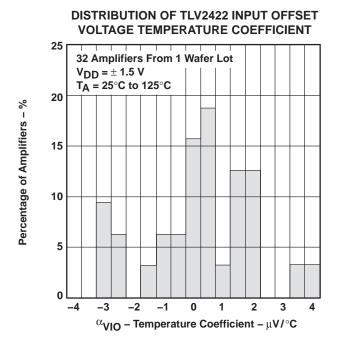


INPUT OFFSET VOLTAGE vs COMMON-MODE INPUT VOLTAGE





TYPICAL CHARACTERISTICS



Percentage of Amplifiers – %

DISTRIBUTION OF TLV2422 INPUT OFFSET VOLTAGE TEMPERATURE COEFFICIENT

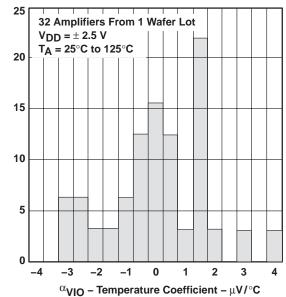
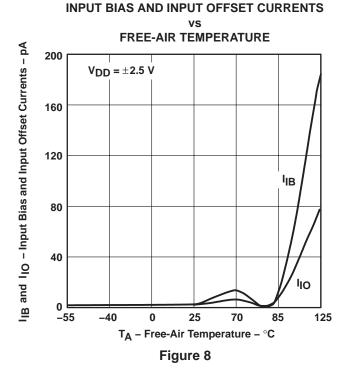
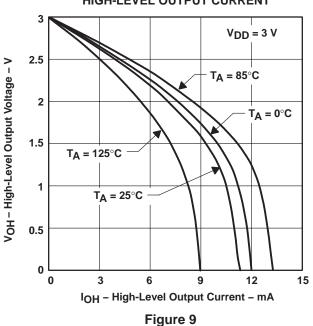


Figure 6

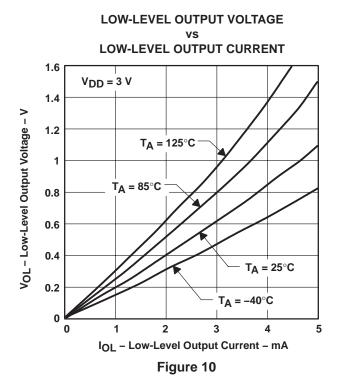
Figure 7

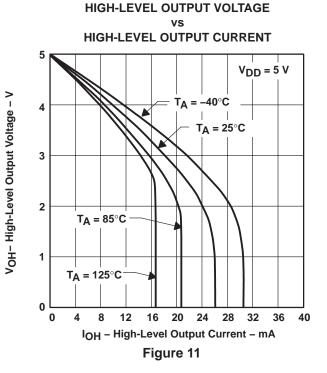


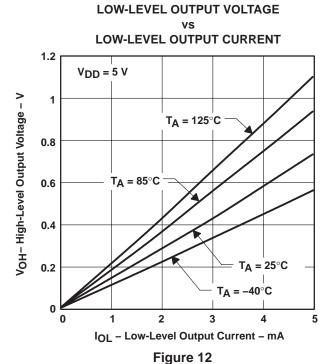
HIGH-LEVEL OUTPUT VOLTAGE
vs
HIGH-LEVEL OUTPUT CURRENT

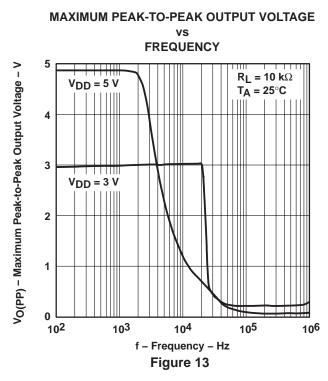


TYPICAL CHARACTERISTICS

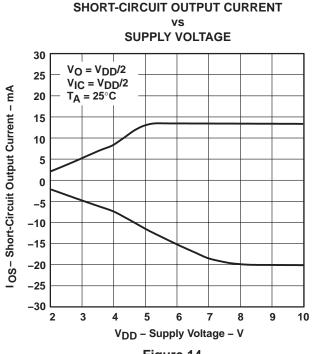








TYPICAL CHARACTERISTICS



SHORT-CIRCUIT OUTPUT CURRENT vs FREE-AIR TEMPERATURE

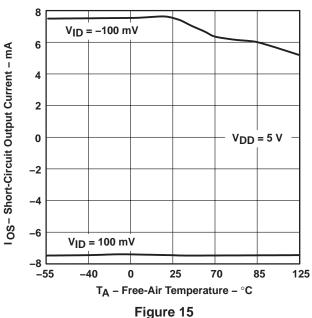
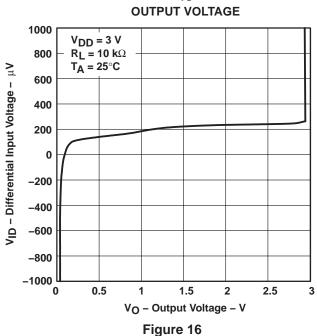
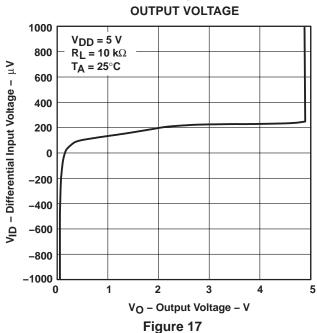


Figure 14

DIFFERENTIAL INPUT VOLTAGE vs



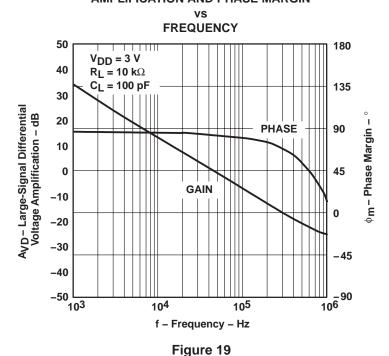
DIFFERENTIAL INPUT VOLTAGE vs



DIFFERENTIAL GAIN VS LOAD RESISTANCE 10000 VID = 5 V VID = 3 V 1000 1000 1000 1000 1000

 R_L – Load Resistance – $k\Omega$ Figure 18

LARGE-SIGNAL DIFFERENTIAL VOLTAGE AMPLIFICATION AND PHASE MARGIN





LARGE-SIGNAL DIFFERENTIAL VOLTAGE AMPLIFICATION AND PHASE MARGIN

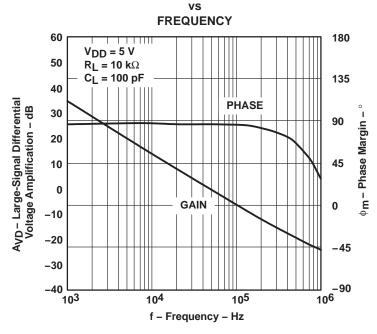


Figure 20

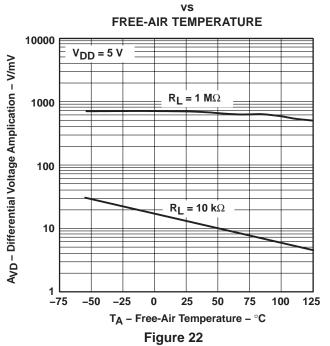
DIFFERENTIAL VOLTAGE AMPLIFICATION

FREE-AIR TEMPERATURE 10000 $V_{DD} = 3 V$ AVD - Differential Voltage Amplication - V/mV $R_L = 1 M\Omega$ 1000 100 $R_L = 10 \text{ k}\Omega$ 10 **-75** -50 -25 25 50 100 125

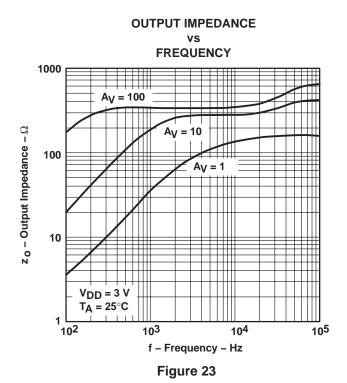
T_A - Free-Air Temperature - °C

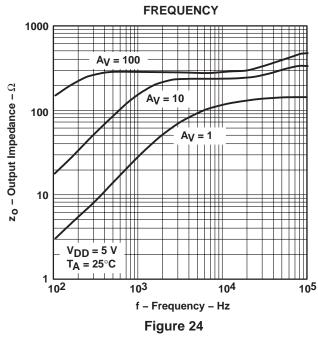
Figure 21

DIFFERENTIAL VOLTAGE AMPLIFICATION









OUTPUT IMPEDANCE

COMMON-MODE REJECTION RATIO vs

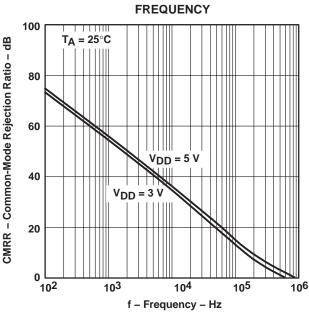
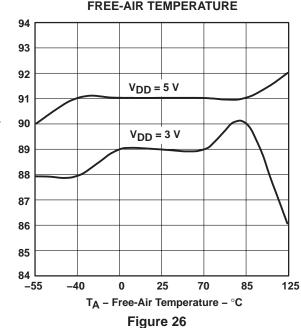
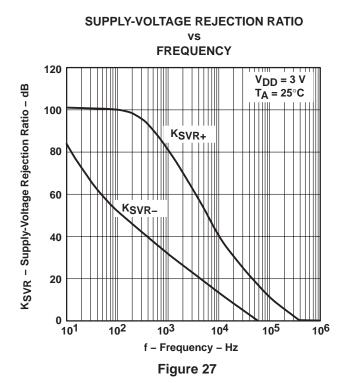


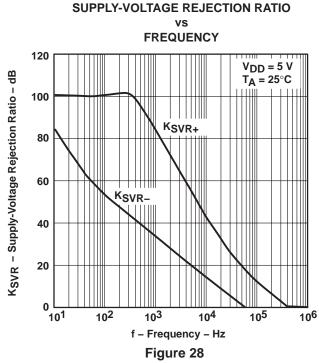
Figure 25

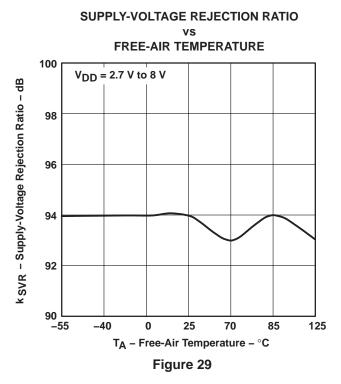
COMMON-MODE REJECTION RATIO vs FREE-AIR TEMPERATURE

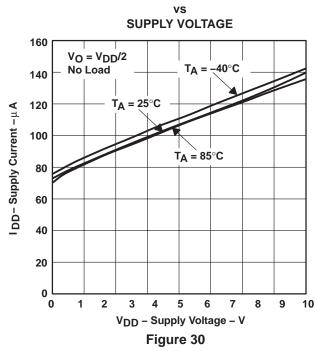


CMRR - Common-Mode Rejection Ratio - dB









SUPPLY CURRENT

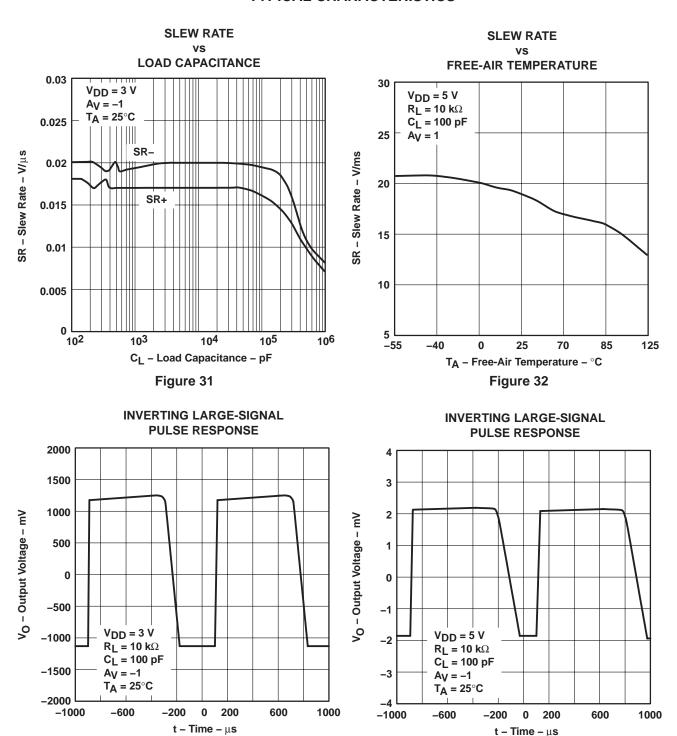




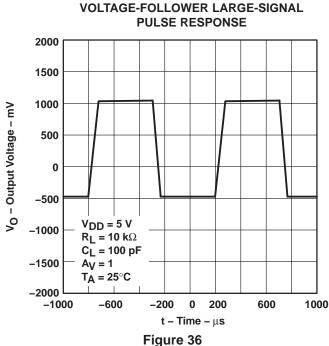
Figure 34

Figure 33

TYPICAL CHARACTERISTICS

VOLTAGE-FOLLOWER LARGE-SIGNAL PULSE RESPONSE 2000 $V_{DD} = 3 V$ $R_L = 10 \text{ k}\Omega$ 1500 $C_{L}^{-} = 100 \text{ pF}$ $A_V = 1$ 1000 $T_A = 25^{\circ}C$ Vo - Output Voltage - mV 500 0 -500 -1000 -1500 -2000 -1000 -600 -200 0 200 1000 $\textbf{t-Time}-\mu\textbf{s}$

Figure 35



INVERTING SMALL-SIGNAL PULSE RESPONSE

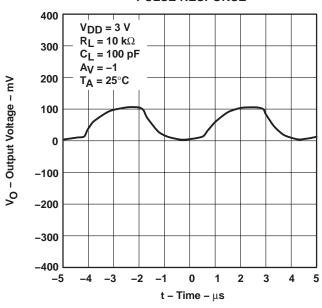


Figure 37

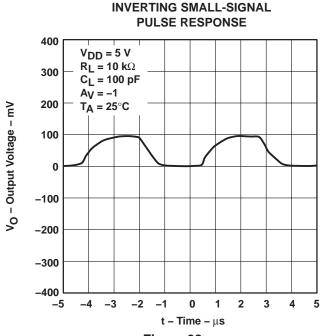


Figure 38

Vo - Output Voltage - mV

VOLTAGE-FOLLOWER SMALL-SIGNAL PULSE RESPONSE 400 $V_{DD} = 3 V$ $R_L = 10 \text{ k}\Omega$ 300 $C_{L} = 100 \text{ pF}$ $A_V = 1$ 200 Vo - Output Voltage - mV T_A = 25°C 100 -100 -200 -300 -400 -5 -3 -2 -1 0 1 4 5 t – Time – μ s



PULSE RESPONSE 400 $V_{DD} = 5 V$ $R_L = 10 \text{ k}\Omega$ 300 C_L = 100 pF $A_V = 1$ 200 $T_A = 25^{\circ}C$ 100 0 -100-200 -300 -400 -4 -3 -2 0 2 3 4 5 -5 -1 t – Time – μ s

VOLTAGE-FOLLOWER SMALL-SIGNAL

Figure 40

EQUIVALENT INPUT NOISE VOLTAGE

EQUIVALENT INPUT NOISE VOLTAGE

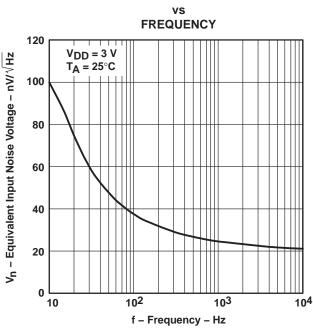


Figure 41

FREQUENCY 120 $V_{DD} = 5 V$ V_n - Equivalent Input Noise Voltage - nV/√Hz T_A = 25°C 100 80 60

102 10 103 f - Frequency - Hz

Figure 42

104

40

20

0

NOISE VOLTAGE OVER A 10-SECOND PERIOD

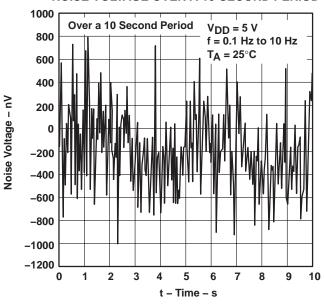


Figure 43

TOTAL HARMONIC DISTORTION PLUS NOISE

vs

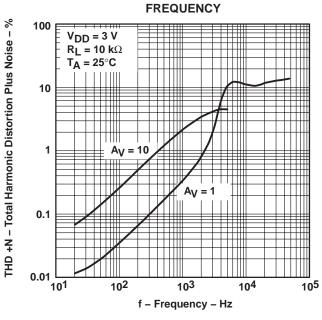


Figure 44

TOTAL HARMONIC DISTORTION PLUS NOISE vs

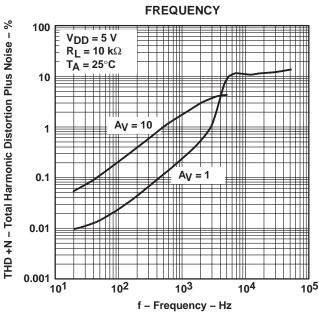
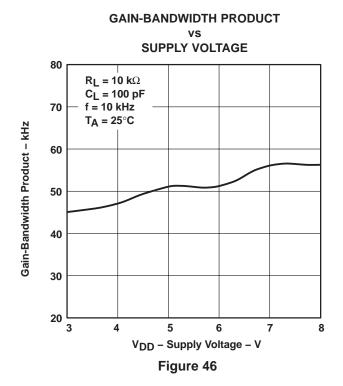
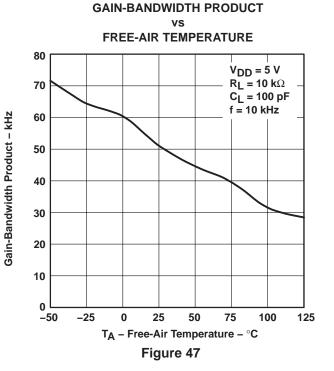
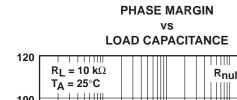
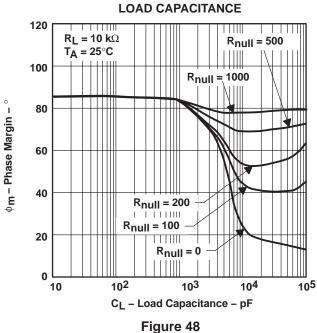


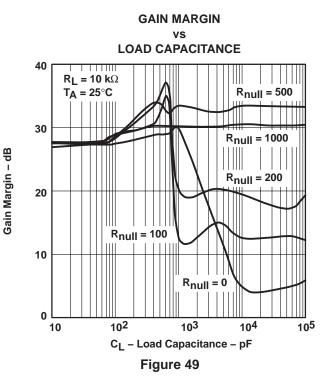
Figure 45











TYPICAL CHARACTERISTICS

UNITY-GAIN BANDWIDTH LOAD CAPACITANCE 60 50 B1 - Unity-Gain Bandwidth - kHz 40 30 20 10 0 103 10 102 104 105 C_L - Load Capacitance - pF

Figure 50





i.com 18-Sep-2008

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
TLV2422AQDRG4Q1	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2422AQDRQ1	ACTIVE	SOIC	D	8	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR Level-1-235C-UNLIM
TLV2422QDRG4Q1	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2422QDRQ1	ACTIVE	SOIC	D	8	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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OTHER QUALIFIED VERSIONS OF TLV2422-Q1, TLV2422A-Q1:

Catalog: TLV2422, TLV2422AMilitary: TLV2422M, TLV2422AM

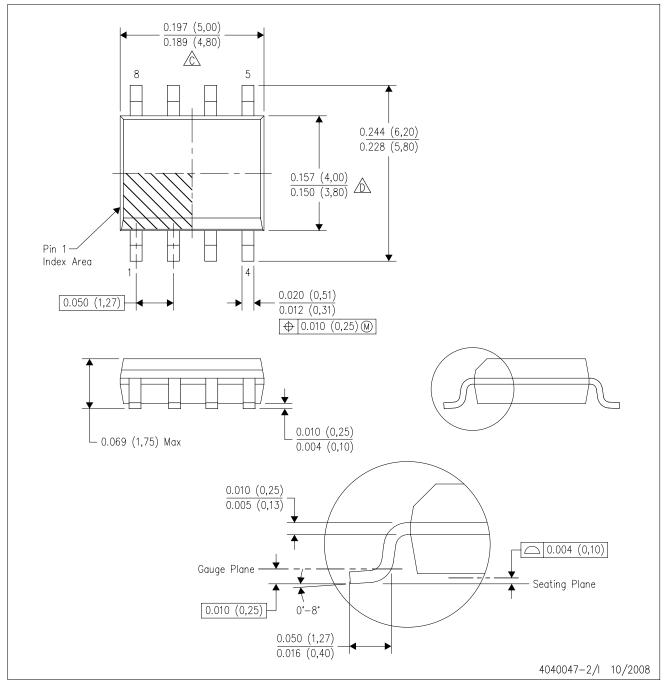
NOTE: Qualified Version Definitions:

• Catalog - TI's standard catalog product

• Military - QML certified for Military and Defense Applications

D (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
- Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
- E. Reference JEDEC MS-012 variation AA.



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